

SK12 THRU SK110

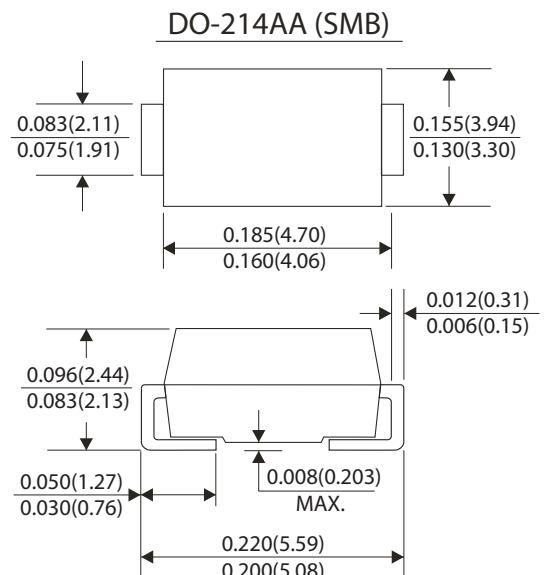
CURRENT 1.0Ampere
VOLTAGE 20 to 100 Volts

Features

- Plastic Package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction, majority carrier conduction
- For surface mount applications
- Guard ring for overvoltage protection
- Low power loss, high efficiency
- High current capability, Low forward voltage drop
- High surge capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- High temperature soldering guaranteed : 250 °C/10 seconds at terminals

Mechanical Data

- Case : JEDEC SMB(DO-214AA) molded plastic body
- Terminals : Solder Plate, solderable per MIL-STD-750, Method 2026
- Polarity : Color band denotes cathode end
- Weight : 0.003 ounce, 0.093 gram



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

(Ratings at 25 °C ambient temperature unless otherwise specified, single phase, half wave, resistive or inductive load. For capacitive load, derate by 20%)

	Symbols	SK12	SK13	SK14	SK15	SK16	SK18	SK19	SK110	Units					
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	80	90	100	Volts					
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	56	63	70	Volts					
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	80	90	100	Volts					
Maximum average forward rectified current 0.375"(9.5mm) lead length(see Fig. 1)	I _(AV)	1.0							Amp						
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	25.0							Amps						
Maximum instantaneous forward voltage at 1.0A (Note 1)	V _F	0.55		0.70		0.85		Volts							
Maximum instantaneous reverse current at rated DC blocking voltage (Note1)	T _A =25 °C	I _R	1.0							mA					
	T _A =100 °C		10												
Typical thermal resistance (Note 2)	R _{θJA}	50							°C/W						
Operating junction temperature range	T _J	-50 to +125							°C						
Storage temperature range	T _{STG}	-65 to +150							°C						

Notes:

- (1) Pulse test: 300μS pulse width, 1% duty cycle
- (2) Thermal resistance junction to ambient

DEC

RATINGS AND CHARACTERISTIC CURVES SK12 THRU SK110

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

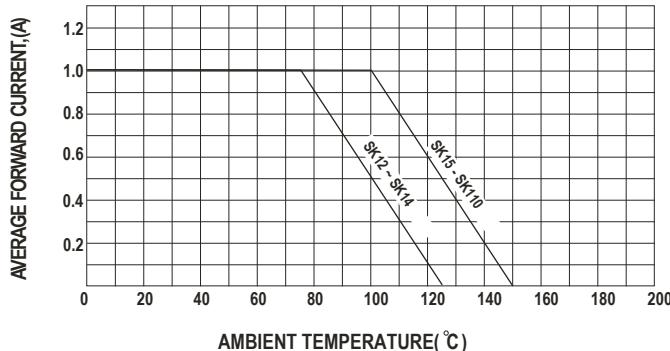


FIG.3-MAXIMUM NON-REPETITIVE FORWARDSURGE CURRENT

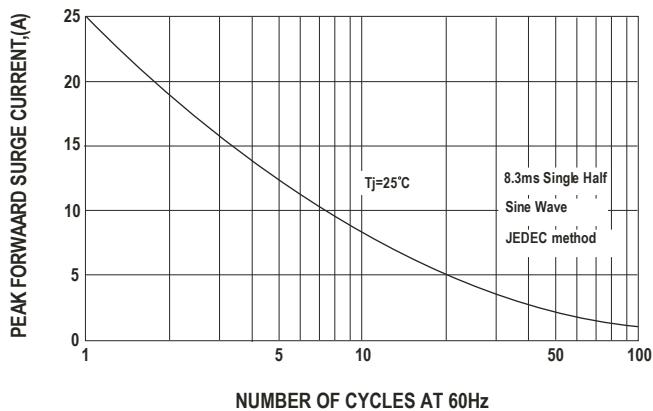


FIG.4-TYPICAL JUNCTION CAPACITANCE

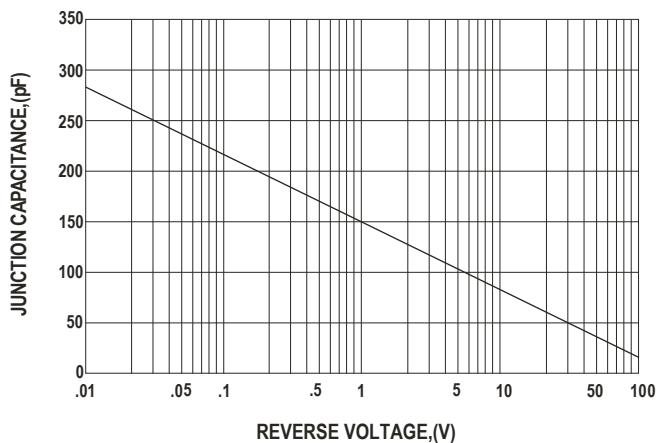


FIG.2-TYPICAL FORWARDCHARACTERISTICS

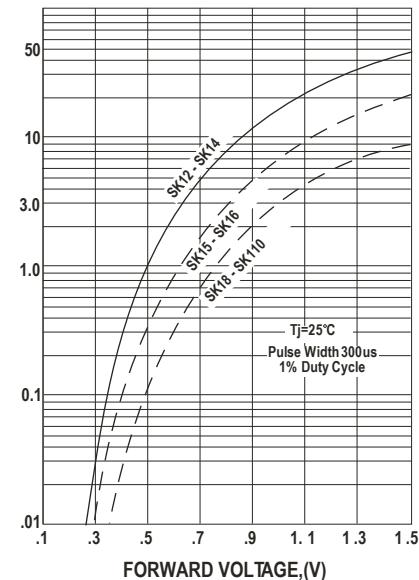


FIG.5 - TYPICAL REVERSECHARACTERISTICS

